

FUJI POWER MOSFET
Super FAP-G Series

■ Features

High speed switching Low on-resistance
No secondary breakdown Low driving power
Avalanche-proof

■ Applications

Switching regulators DC-DC converters
UPS (Uninterruptible Power Supply)

■ Maximum ratings and characteristic

● Absolute maximum ratings
(T_c=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit	Remarks
Drain-source voltage	V _{DS}	250	V	
	V _{DSX}	220	V	V _{GS} =-30V
Continuous Drain Current	I _D	34	A	
Pulsed Drain Current	I _D (puls)	±136	A	
Gate-Source Voltage	V _{GS}	±30	V	
Maximum Avalanche current	I _{AR}	34	A	Note *1
Non-Repetitive Maximum Avalanche Energy	E _{AS}	665.7	mJ	Note *2
Repetitive Maximum Avalanche Energy	E _{AR}	27	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	20	kV/μs	V _{DS} ≤250V
Peak Diode Recovery dV/dt	dV/dt	5	kV/μs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/μs	Note *5
Max. Power Dissipation	P _D	270	W	T _c =25°C
		2.02		T _a =25°C
Operating and Storage Temperature range	T _{ch}	+150	°C	
	T _{stg}	-55 to +150	°C	

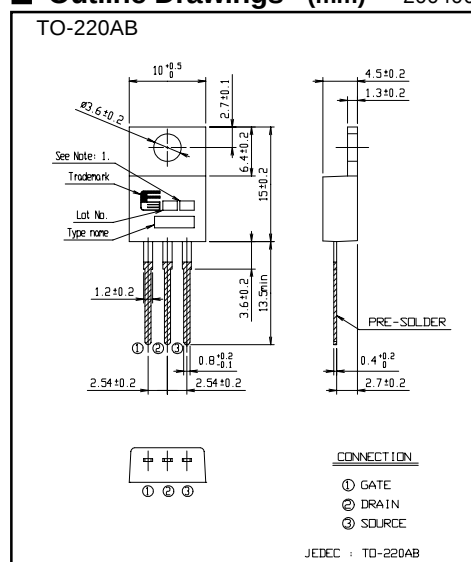
● Electrical characteristics (T_c=25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V	250			V
Gate Threshold Voltage	V _{GS(th)}	I _D =250μA V _{DS} =V _{GS}	3.0		5.0	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =250V V _{GS} =0V			25	μA
		V _{DS} =200V V _{GS} =0V			2.0	mA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V V _{DS} =0V			100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =17A V _{GS} =10V		85	110	mΩ
Forward Transconductance	g _{fs}	I _D =17A V _{DS} =25V	13	26		S
Input Capacitance	C _{iss}	V _{DS} =75V		1850	2800	pF
Output Capacitance	C _{oss}	V _{GS} =0V		220	330	
Reverse Transfer Capacitance	C _{rss}	f=1MHz		21	32	
Turn-On Time t _{on}	td(on)	V _{CC} =48V I _D =17A		20	30	ns
	t _r	V _{GS} =10V		19	29	
Turn-Off Time t _{off}	td(off)	R _{GS} =10Ω		56	85	
	t _f			19	29	
Total Gate Charge	Q _G	V _{CC} =125V		56	85	nC
Gate-Source Charge	Q _{GS}	I _D =34A		20	30	
Gate-Drain Charge	Q _{GD}	V _{GS} =10V		19	29	
Diode forward on-voltage	V _{SD}	I _F =34A V _{GS} =0V T _{ch} =25°C		1.00	1.50	V
Reverse recovery time	t _{rr}	I _F =34A V _{GS} =0V		140	250	ns
Reverse recovery charge	Q _{rr}	-di/dt=100A/μs T _{ch} =25°C		0.5	1.25	μC

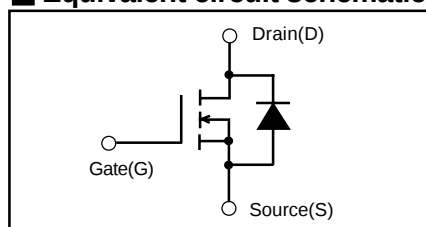
● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)}	channel to case			0.463	°C/W
	R _{th(ch-a)}	channel to ambient			62	°C/W

■ Outline Drawings (mm) 200406



■ Equivalent circuit schematic

Note *1: T_{ch} ≤ 150°C, Repetitive and Non-repetitiveNote *2: Starting T_{ch}=25°C, I_{AS}=14A, L=5.71mH,V_{CC}=48V, R_G=50Ω

EAS limited by maximum channel temperature and avalanche current.

See to the 'Avalanche Energy' graph

Note *3: Repetitive rating: Pulse width limited by maximum channel temperature.

See to the 'Transient Thermal impedance' graph

Note *4: I_F ≤ -I_D, -di/dt=100A/μs, V_{CC} ≤ BV_{DSS}, T_{ch} ≤ 150°CNote *5: I_F ≤ -I_D, dv/dt=5kV/μs, V_{CC} ≤ BV_{DSS}, T_{ch} ≤ 150°C

Characteristics

